UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/563,854	06/09/2006	Euijoon Yoon	20506/0203830-US0	3828
7278 DARBY & DA	7590 02/25/201 <sup>1</sup> RBY P.C.	EXAMINER		
P.O. BOX 770 Church Street S	_	MALDONADO, JULIO J		
New York, NY		ART UNIT	PAPER NUMBER	
			2823	
			MAIL DATE	DELIVERY MODE
			02/25/2010	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)		
10/563,854	YOON ET AL.		
Examiner	Art Unit		
JULIO J. MALDONADO	2823		

J	ULIO J. MALDONADO	2823	
The MAILING DATE of this communication appear	s on the cover sheet with the d	correspondence add	ress
THE REPLY FILED <u>08 February 2010</u> FAILS TO PLACE THIS AI	PPLICATION IN CONDITION FO	R ALLOWANCE.	
1. The reply was filed after a final rejection, but prior to or on th application, applicant must timely file one of the following re application in condition for allowance; (2) a Notice of Appea for Continued Examination (RCE) in compliance with 37 CF periods:	e same day as filing a Notice of a plies: (1) an amendment, affidavi (with appeal fee) in compliance	Appeal. To avoid abar t, or other evidence, w with 37 CFR 41.31; or	hich places the (3) a Request
a) The period for reply expires 3 months from the mailing date of b) The period for reply expires on: (1) the mailing date of this Adv no event, however, will the statutory period for reply expire late Examiner Note: If box 1 is checked, check either box (a) or (b) MONTHS OF THE FINAL REJECTION. See MPEP 706.07(f).	isory Action, or (2) the date set forth r than SIX MONTHS from the mailing	g date of the final rejectio	n.
Extensions of time may be obtained under 37 CFR 1.136(a). The date on have been filed is the date for purposes of determining the period of exter under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the shouset forth in (b) above, if checked. Any reply received by the Office later the may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  NOTICE OF APPEAL	sion and the corresponding amount or trened statutory period for reply origi	of the fee. The appropria nally set in the final Offic	te extension fee e action; or (2) as
<ol> <li>The Notice of Appeal was filed on A brief in complia filing the Notice of Appeal (37 CFR 41.37(a)), or any extens Notice of Appeal has been filed, any reply must be filed with AMENDMENTS</li> </ol>	on thereof (37 CFR 41.37(e)), to	avoid dismissal of the	
3. The proposed amendment(s) filed after a final rejection, bu  (a) They raise new issues that would require further cons  (b) They raise the issue of new matter (see NOTE below)  (c) They are not deemed to place the application in better	deration and/or search (see NOT;	ΓE below);	
appeal; and/or (d) They present additional claims without canceling a continuation Sheet. (See 37 CFR 1.116	responding number of finally reje and 41.33(a)).	ected claims.	
<ol> <li>The amendments are not in compliance with 37 CFR 1.121</li> <li>Applicant's reply has overcome the following rejection(s): _</li> <li>Newly proposed or amended claim(s) would be allow</li> </ol>			,
non-allowable claim(s). 7. ☑ For purposes of appeal, the proposed amendment(s): a) ☑	will not be entered, or b)  wil		
how the new or amended claims would be rejected is provid The status of the claim(s) is (or will be) as follows:  Claim(s) allowed:  Claim(s) objected to: 13.  Claim(s) rejected: 1, 3-12 and 14-19.  Claim(s) withdrawn from consideration:	ed below of appended.		
AFFIDAVIT OR OTHER EVIDENCE			
<ol> <li>The affidavit or other evidence filed after a final action, but because applicant failed to provide a showing of good and swas not earlier presented. See 37 CFR 1.116(e).</li> </ol>	ufficient reasons why the affidavi	it or other evidence is	necessary and
9. The affidavit or other evidence filed after the date of filing a entered because the affidavit or other evidence failed to ove showing a good and sufficient reasons why it is necessary a	rcome <u>all</u> rejections under appea	al and/or appellant fails	to provide a
10.		•	
11. The request for reconsideration has been considered but described See Continuation Sheet.		condition for allowand	ce because:
12.	1 0/36/06) Paper No(s)		
	/Julio J. Maldonado/ Primary Examiner, Art U	Init 2823	

Continuation of 3. NOTE: The amendment filed 02/08/2010 in reply to the final rejection has been considered but is not deemed to place the application in condition for allowance and will not be entered because the proposed amendment raises new issues that would require further consideration and/or search. The amended independent claims now add the limitation "...a fourth step of growing a fourth nitride semiconductor epitaxial layer on the third nitride semiconductor epitaxial layer after releasing nitrogen form the second nitride semiconductor epitaxial layer" as disclosed in claim 1; "...after converting the InN layer into the metal layer", as disclosed in claim 15; and "...a fourth step of growing a third nitride semiconductor epitaxial layer on the second nitride semiconductor epitaxial layer after releasing nitrogen from the first nitride semiconductor epitaxial layer", as disclosed in claim 16, where there was no mention within the claims of this limitation. The amendment raises new issues into the prosecution of the instant application and would thus provide grounds for a new search and further consideration.

Continuation of 11. does NOT place the application in condition for allowance because: Applicant's arguments filed 02/08/2010 have been fully considered but they are not persuasive.

The applicants argue, "...The Examiner contends that Chua describes growing a fourth nitride semiconductor epitaxial layer on the third nitride semiconductor epitaxial layer after releasing nitrogen from the second nitride semiconductor epitaxial layer. In reference to Chua, the Examiner states that the second Distributed Bragg Reflector ("DBR") 142, which can be formed of alternating GaN/A1GaN layers, is equivalent to the fourth nitride semiconductor epitaxial layer of amended claim 1. Chua, column 7, lines 1-7. Applicant respectfully disagrees. The second DBR 142 of Chua is not equivalent to the fourth nitride semiconductor layer of amended claim 1 because the second DBR 142 is not formed after releasing the nitrogen of the InGaN layer 106, which the Examiner equates to the second semiconductor epitaxial layer of claim 1. Rather, the second DBR 142 of Chua is formed after the sapphire substrate 100, the gallium nitride layers 102 and 104, and the InGaN layer 106 are separated from the semiconductor structure by a laser beam. Chua, column 6, lines 14-29. Kelly also fails to describe those features demonstrated to be missing from Chua..."

In response to this argument, the Chua discloses performing a separation process with a laser beam (See Chua, Fig.2 and column 6, lines 14 - 65), and forming a fourth nitride layer over a third nitride layer after performing said separation (Chua, column 7, lines 1 - 7). Chua fails to expressly disclose releasing nitrogen form an InGaN layer. However, and as stated in the office action mailed 12/08/2009, Kelly discloses a method of forming nitride semiconductor layers including forming III-nitride semiconductor layers and performing a decomposition process on a III-nitride semiconductor layer (Kelly, column 8, lines 8 - 58). Accordingly, it would have been within the scope of one of ordinary skill in the art to combine the teachings of Chua and Kelly to enable releasing the nitrogen from the InGaN layer of Chua according to the teachings of Kelly because one of ordinary skill in the art would have been motivated to look to analogous art teaching alternative suitable or useful methods of releasing the nitrogen in the InGaN layer of Chua and art recognized suitability for an intended purpose has been recognized to be motivation to combine. MPEP 2144.07. Therefore, the combination of Chua and Kelly discloses forming a fourth nitride layer over a third nitride after performing a separation process, which in this case, said separation releases nitrogen from an InGaN layer.

Applicants argue, "...The purpose of converting the second semiconductor epitaxial layer into a metal layer by releasing nitrogen is to reduce stresses associated with growing the fourth semiconductor epitaxial layer on the third nitride semiconductor epitaxial layer. See Applicants Published Specification, paragraph 28. By reducing stresses, the metal layer also reduces warpage of the fourth nitride semiconductor epitaxial layer or warpage of other nitride semiconductor epitaxial layers grown on the fourth layer. See Applicants' Published Specification, paragraph 28. In contrast, Chua discloses that the nitrogen is released from the InGaN 106 layer after seven additional nitride layers, a first distributed Bragg reflector, a gold layer and a silicon substrate are grown on the InGaN layer. Chua, column 5, lines 11-58. As such, the nitrogen is released from the InGaN layer after the growing of subsequent nitride layers and does not reduce the stresses on and warpage of the subsequent nitride layers. Due to the fact that the purpose of releasing the nitrogen from the InGaN layer in Chua is different from the purpose of releasing the nitrogen from the second semiconductor epitaxial layer of the present invention, Chua teaches away from the invention of amended claim 1..."

In response to this argument, the examiner respectfully submits that the combination of Chua and Kelly discloses the claimed invention. The combination of Chua and Kelly discloses a process of separating a series of nitride layers from a substrate by releasing nitrogen from an InGaN layer and the examiner respectfully submits that the combination of Chua and Kelly does not teach away from the invention of amended claim 1, as argued by the applicants.